L Number	Hits	Search Text	DB	Time stamp
2	26860	((laser diode) and (case module)).ab.	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:44
3	1598	(((laser diode) and (case module)).ab.) and 372/$.ccls.	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:36
4	620	((((laser diode) and (case module)).ab.) and 372/$.ccls.) and semiconductor.ab.	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:37
5	30	(((((laser diode) and (case module)).ab.) and 372/$.ccls.) and semiconductor.ab.) and hole.ab.	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:38
6	28	(((((laser diode) and (case module)).ab.) and 372/$.ccls.) and semiconductor.ab.) and hole with (case module)	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:42
7	13	(((((laser diode) and (case module)).ab.) and 372/$.ccls.) and semiconductor.ab.) and opening with (case module)	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:42
8	13731	((laser diode) with (case module)).ab.	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:44
9	1159	(((laser diode) with (case module)).ab.) and (hole opening).ab.	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:44
10	679	(((laser diode) with (case module)).ab.) and ((hole opening) with (case module)).ab.	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:46
11	40	((((laser diode) with (case module)).ab.) and ((hole opening) with (case module)).ab.) and 372/$.ccls.	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:50
14	146	semiconductor with laser with module and module with (opening hole)	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:52
15	51	372/36,109.ccls. and (case module) with (hole opening)	USPAT; EPO; JPO; IBM_TDB	2003/08/21 14:53
16	16	4567598.URPN.	USPAT	2003/08/21 15:05
17	3	("3816847" | "3869702" | "4295152").PN.	USPAT	2003/08/21 15:06

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